

TITLE: ETCHANT FORMULATION FOR SELECTIVELY REMOVING THIN FILMS IN PRESENCE OF
 COPPER, TIN, AND LEAD
 INVENTORS NAME: Donald Danielson et al.
 DOCKET NO.: 884.614US1

1/4

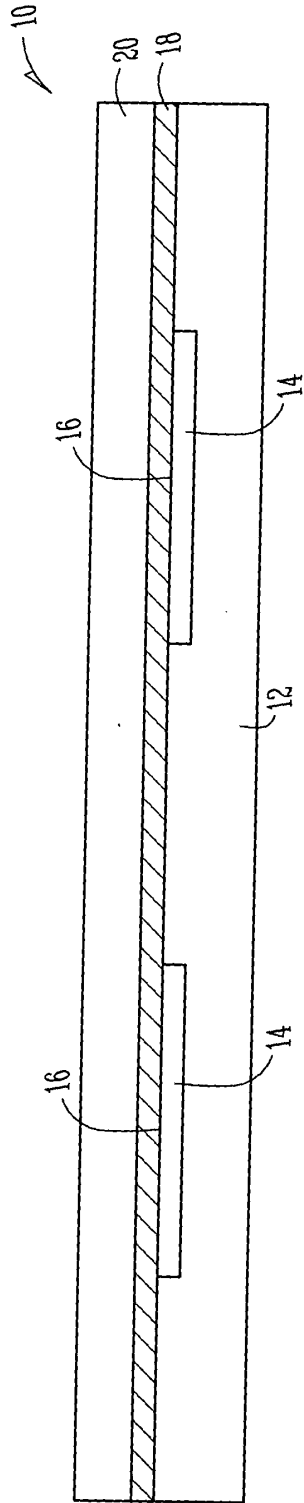


Fig. 1

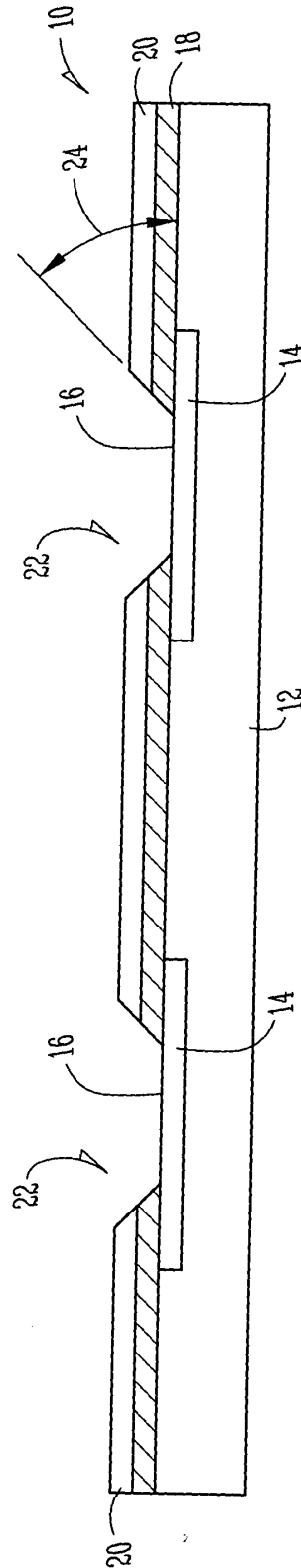


Fig. 2

TITLE: ETCHANT COMPOSITION FOR SELECTIVELY REMOVING THIN FILMS IN THE PRESENCE OF
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3/4

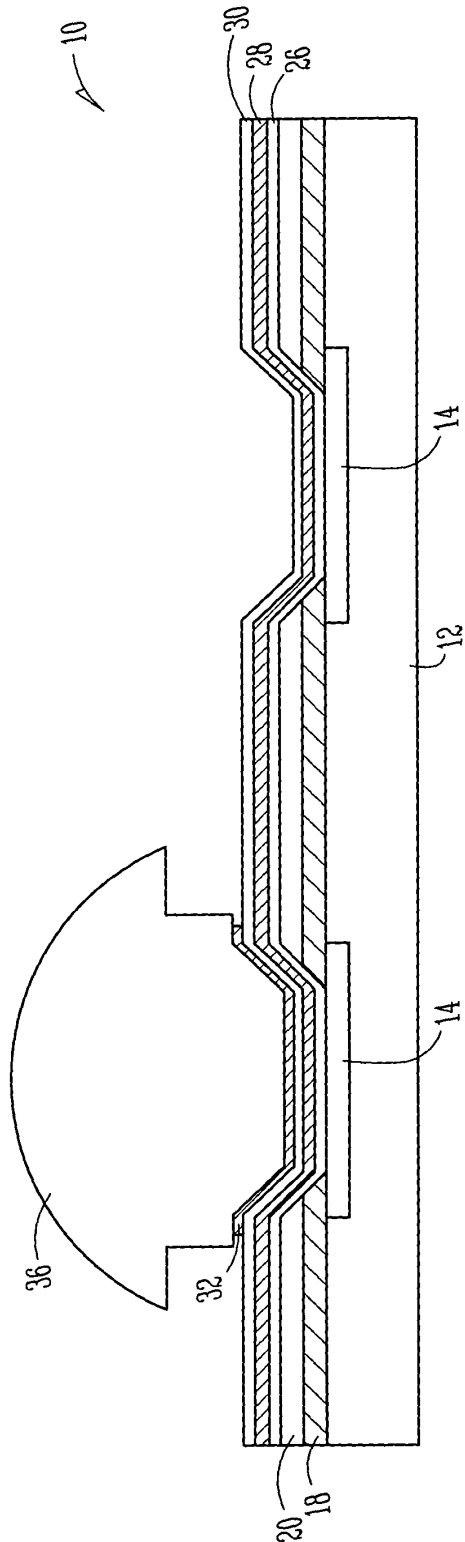


Fig. 5

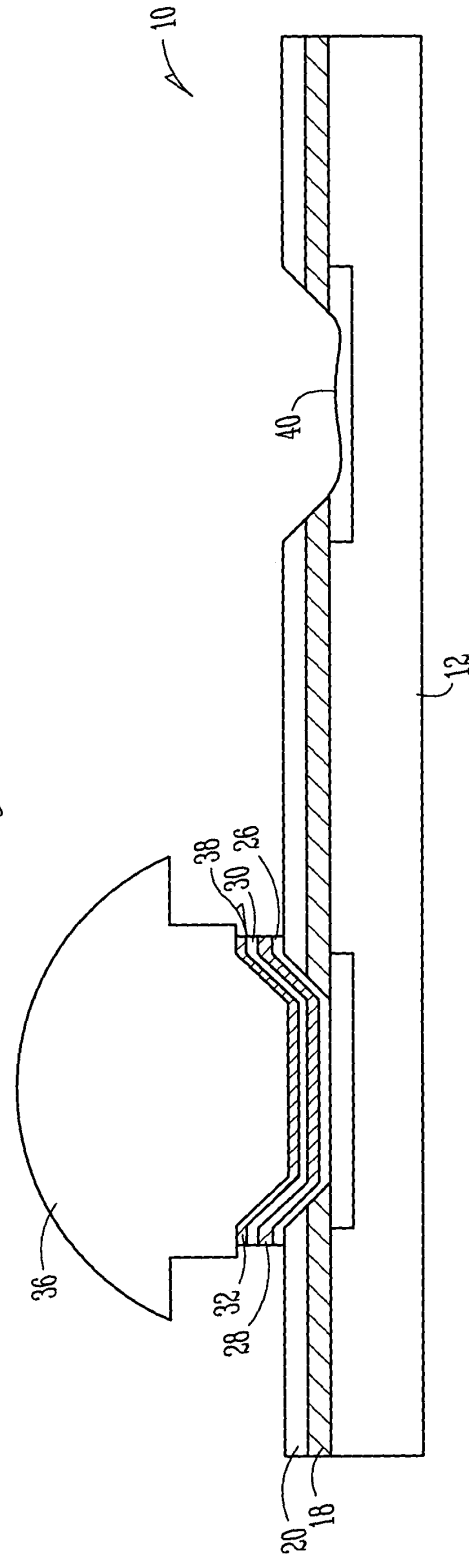
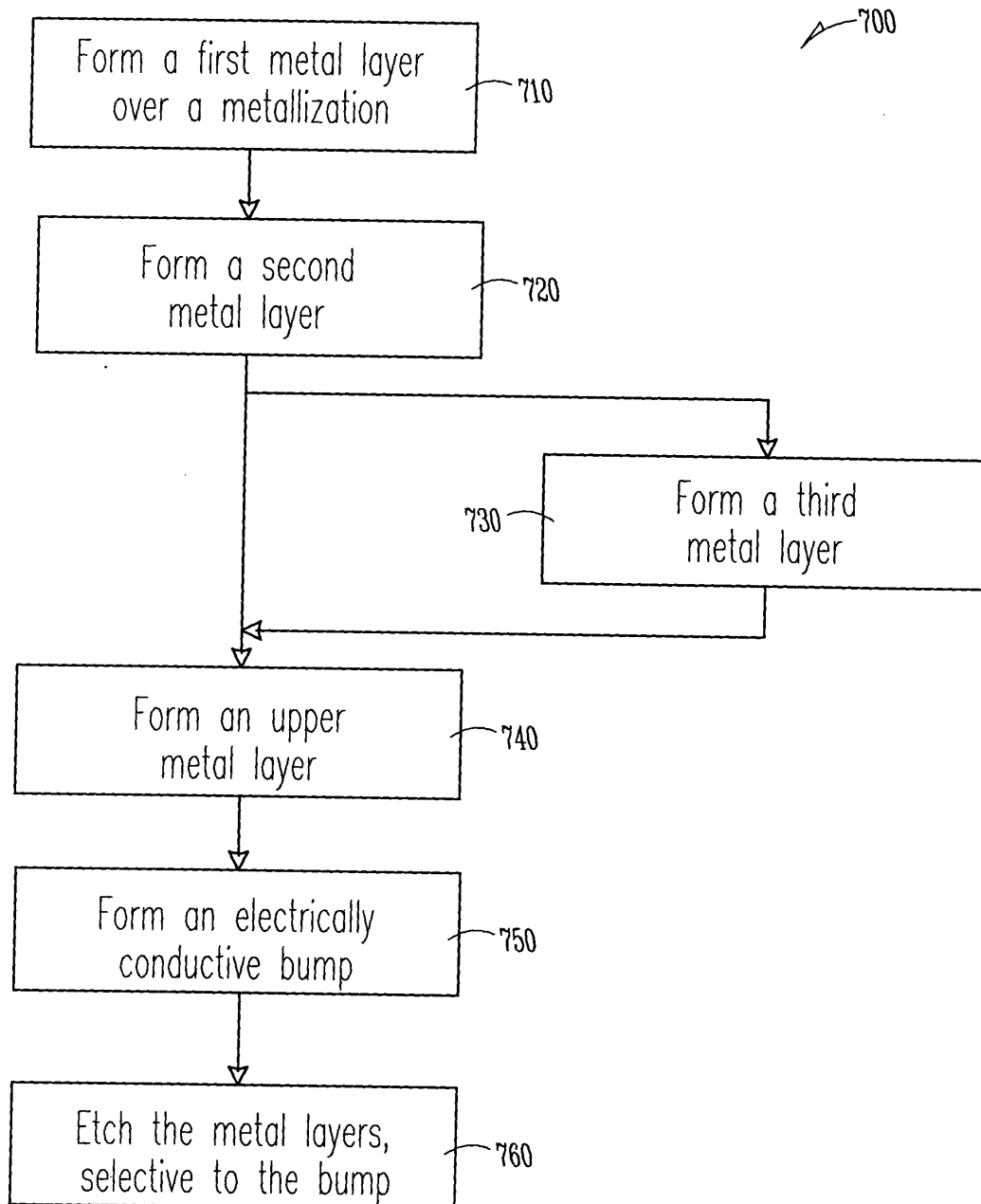


Fig. 6

*Fig. 7*